

What is “JSAP”?

The activities of JSAP (The Japan Society of Applied Physics) center on the field of applied physics. In applied physics, the Society plays a key dual role by acting as an academic interface between science and engineering and stimulating social interaction between academia and industry.

JSAP has focused most of its energies to date on organising technical meetings and conferences as a means of encouraging mutually beneficial collaboration between researchers working in applied physics.

Update

(1) The 2004 Fall Meeting was held at Tohoku Gakuin University with 6,539 registered participants and 3,756 presentations. Abstracts for the presentations were only accepted using a new on-line submission system via the JSAP website.

(2) The JSAP 2005 Spring Meeting will be held at Saitama University, Saitama City, March 29–April 1.

(3) JJAP Part 1 now accepts online submission of manuscripts via the JJAP web page: <http://jjap.ipap.jp/online/>. Further, from October 2003, IPAP has started publishing an online version of the Japanese Journal of Applied Physics, well in advance of the printed version.

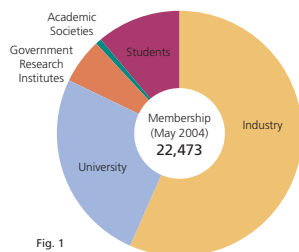
(4) ‘The JJAP Editorial Contribution Award’ was established to recognize distinguished contributions as an editor and/or a reviewer of articles for the Japanese Journal of Applied Physics.

(5) The JSAP sponsored 18 international conferences in 2004 including the SSDM, VLSI, AMLCD, MNC, ISOM, EM-NANO, IWDTE, ISLC, IISC, IPRM.

Membership

The total membership of JSAP was 22,473 as of May 2004, with members specialising in physics, applied physics, electronics, chemistry, communications, materials science, metallurgy, and mechanical engineering.

About two-thirds of the members of JSAP are recruited from industry and one third of members are based mainly in academic institutions and government laboratories (Fig. 1).



Publications

JSAP publishes the monthly journal *Oyo Buturi*, a Japanese-language membership journal containing review articles. The JSAP also publishes a separate two-part periodical in English, the Japanese Journal of Applied Physics (JJAP), where Part 1 is published monthly and Part 2 bimonthly. Part 1 is dedicated to regular papers, short notes and review papers and Part 2 to letters. Furthermore, submissions judged to have a large impact factor and as requiring urgent publication, are processed more rapidly and published in the Express Letters section of Part 2. Approximately, 3,000 copies each of JJAP Part 1 and JJAP Part 2 were printed and distributed in 2000, and more than 600 copies were despatched to subscribers in 50 countries.

In addition to the above periodicals, JSAP publishes books and the proceedings of various international conferences sponsored or co-sponsored by JSAP in fields related to applied physics. Members receive a discount on these publications.

Academic Meetings

The JSAP holds two national conventions annually, in which a third of the JSAP membership generally participates. The Spring meeting (held in the Tokyo area) usually involves about 8,000 participants and the Autumn meeting (held in other parts of Japan, such as Nagoya) attracts approximately 6,000 participants. The two conventions are held over a period of four days during which about 4,000 papers are presented in regular sessions and symposia.

International Conferences

JSAP sponsored more than 18 international conferences in the fields of applied physics and related subjects in 2004. In that year, the list of major international conferences held under the sponsorship of, or in cooperation with, JSAP included Nitride Semiconductors, VLSI Technology, Modulated Semiconductor Structures, Microprocesses and Nanotechnology, Solid State Devices and Materials, and Atomically Controlled Surfaces, Interfaces and Nanostructures.

Divisional Activities

JSAP has various divisions that take responsibility for particular subject areas. Each division sponsors activities in its own field of specialisation that include seminars, tutorial meetings, and the publication of newsletters. The divisions that exist currently are

- Education in Applied Physics
- Materials Science and Crystal Technology
- Optics
- Organic Molecular Electronics and Bioelectronics

- Plasma Electronics
- Radiation Science
- Silicon Technology
- Solid State Physics and Applications
- Superconductors
- Thin Film and Surface Physics

JSAP Awards

Outstanding achievement in the field of applied physics is recognized by the presentation of a ‘JSAP Outstanding Achievement Award’ to individuals who have greatly contributed to the progress of applied physics.

Awards are also presented to the authors of papers of excellence published in the two main JSAP periodicals, the membership journal (*Oyo Buturi*) and the Japanese Journal of Applied Physics (JJAP). There are three awards:

- Award for the best original paper
- Award for the most promising young scientist
- Award for the best review paper

Benefits of JSAP Membership

- Free copy of the monthly publication *Oyo Buturi*
- Discount on subscriptions to JJAP Part 1 and JJAP Part 2
- Eligibility to present papers at JSAP meetings
- Discount on JSAP-sponsored conference fees
- Discount on books and conference proceedings published by JSAP
- Access to on-line archive of back numbers of JSAP periodicals
- Participation in meetings organised by societies with formal reciprocal agreements with JSAP (APS, EPS, IEEE/EDS, IEEE/LEOS, IOP, KPS, OSA) at mutual membership rates

How do you join JSAP?

Eligibility for Membership

An individual applying for regular membership should have an interest in applied physics. An applicant for student membership must be a full-time undergraduate or postgraduate student actively involved in research related to applied physics.

Membership fees

The admission fee at registration is 2,000 Yen for a regular member or 1,000 Yen for a student member; and the basic annual subscription fee is 10,000 Yen (plus overseas postage) for regular members or 6,000 Yen (plus overseas postage) for a student member. Members wishing to subscribe to the JJAP are requested to pay 12,000 Yen (plus overseas surface-postage mail) in advance in addition to the basic annual subscription fee.